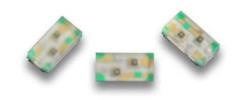


KPHB-1608ZGSURKC-GX





DESCRIPTIONS

- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode
- The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- Electrostatic discharge and power surge could damage the LEDs
- . It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- All devices, equipments and machineries must be electrically grounded

FEATURES

- 1.6 x 0.8 mm SMD LED, 0.5 mm thickness
- · Compatible with reflow soldering
- · Available in various color combination
- · Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- Tinned pads for improved solderability
- RoHS compliant

APPLICATIONS

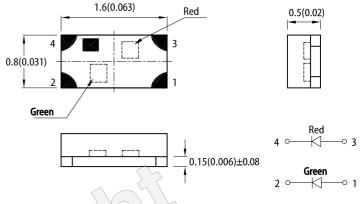
- Backlight
- · Status indicator
- · Home and smart appliances
- · Wearable and portable devices
- · Healthcare applications

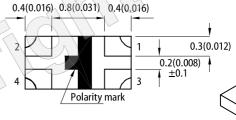
ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices



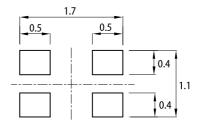
PACKAGE DIMENSIONS





RECOMMENDED SOLDERING PATTERN

(units: mm; tolerance: ± 0.1)



- 1. All dimensions are in millimeters (inches)
- Tolerance is ±0.15(0.006") unless otherwise noted.
 The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice

vice has a single mounting surface. The device must be mounted according to the specifications.

SELECTION GUIDE

Part Number	Emitting Color	Lens Type	lv (mcd) @	20mA ^[2]	Viewing Angle [1]	
r art Number	(Material)	Lens Type	Min.	Тур.	201/2	
	Croon (InCaN)		200	400		
KDUD 40007COUDICO CV	Green (InGaN)	Green (mgan)	Water Class	*200	*400	4000
KPHB-1608ZGSURKC-GX	■ Hyper Red (AlGaInP)	Water Clear	120	250	130°	
			*40	*90		

Notes.

1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Luminous intensity / luminous flux: +/-15%.

* Luminous intensity value is traceable to CIE127-2007 standards.





ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symala al		lue	Unit	
rarameter	Symbol		Тур.	Max.	Unit
Wavelength at Peak Emission I _F = 20mA	λ_{peak}	Green Hyper Red	515 645	-	nm
Dominant Wavelength I _F = 20mA	λ _{dom} ^[1]	Green Hyper Red	525 630	-	nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 20mA	Δλ	Green Hyper Red	30 28	-	nm
Capacitance	С	Green Hyper Red	45 35	-	pF
Forward Voltage I _F = 20mA	V _F ^[2]	Green Hyper Red	3.3 1.95	4.1 2.5	V
Reverse Current (V _R = 5V)	I _R	Green Hyper Red	-	50 10	μA

Notes:

Notes:

1. The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd: ±1nm.)

2. Forward voltage: ±0.1V.

3. Wavelength value is traceable to CIE127-2007 standards.

4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

ABSOLUTE MAXIMUM RATINGS at T_a=25°C

Devenueten	Oh	Value		
Parameter	Symbol	Green	Hyper Red	Unit
Power Dissipation	P _D	102.5	75	mW
Reverse Voltage	V _R	5	5	٧
Junction Temperature	T _j	115	115	°C
Operating Temperature	T _{op}	-40 to	°C	
Storage Temperature	T _{stg}	-40 to	°C	
DC Forward Current	I _F	25	30	mA
Peak Forward Current	I _{FM} ^[1]	150	185	mA
Electrostatic Discharge Threshold (HBM)	-	450	3000	V

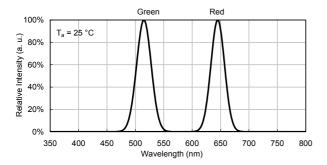
Notes:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.



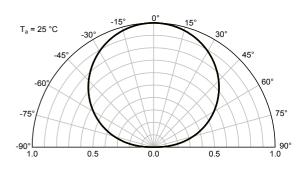


TECHNICAL DATA

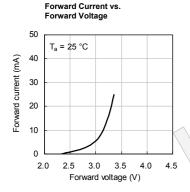
RELATIVE INTENSITY vs. WAVELENGTH

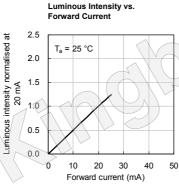


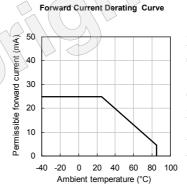
SPATIAL DISTRIBUTION

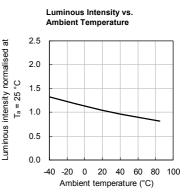


GREEN

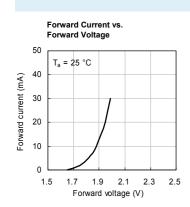


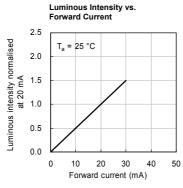


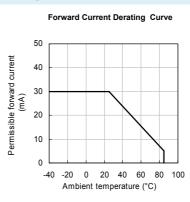


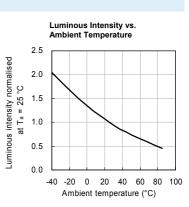


HYPER RED







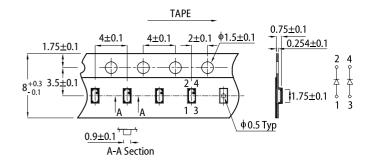




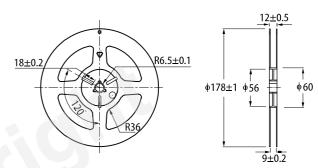
REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

300 above 255°C (°C 260°C max. 30s max. 10s max. 250 3°C/s max. 6°C/s max. 200 150 Temperature pre-heating 100 150~200°C above 217°C 60~120s 60~150s 50 _25°C 0 n 50 100 150 200 250 300 (sec) Time

TAPE SPECIFICATIONS (units: mm)



REEL DIMENSION (units:mm)



Notes

- Don't cause stress to the LEDs while it is exposed to high temperature
- The maximum number of reflow soldering passes is 2 times.
 Reflow soldering is recommended. Other soldering methods cause damage to the product.

PACKING & LABEL SPECIFICATIONS





PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.
- The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.

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- All design applications should refer to Kingbright application notes available at https://doi.org/10.1003/https://doi.org/10.1

